

BUT12AX Silicon diffused power transistor Rev. 01 — 16 June 2004

**Product data** 

## 1. Product profile

### 

## 2. Pinning information

Table 1: Pinning - SOT186A (TO-220F), simplified outline and symbol

Pin	Description	Simplified outline	Symbol	
1	base (b)		2	
2	collector (c)	mb	2 J	
3	emitter (e)	$\circ \circ \circ$	1	
mb	mounting base; isolated			
		() () () () () () () () () () () () () (		
		SOT186A (TO-220F)		



# 3. Ordering information

Table 2: Ordering information							
Type number Package							
	Name	Description	Version				
BUT12AX	TO-220F	Plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3 leads.	SOT186A				

# 4. Limiting values

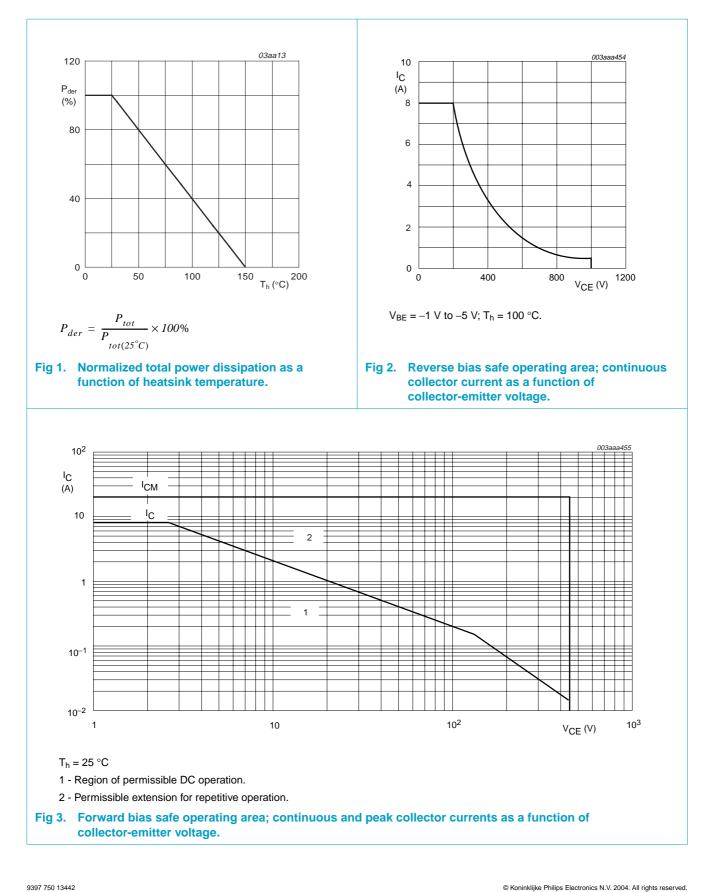
#### Table 3: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Мах	Unit
V <sub>CESM</sub>	peak collector-emitter voltage	V <sub>BE</sub> = 0 V	-	1000	V
$V_{CEO}$	collector-emitter voltage	base open circuit	-	450	V
I <sub>C</sub>	collector current	Figure 2 and 3	-	8	А
I <sub>Csat</sub>	collector saturation current		-	5	А
I <sub>CM</sub>	peak collector current	Figure 3	-	20	А
I <sub>B</sub>	base current (DC)		-	4	А
I <sub>BM</sub>	peak base current		-	6	А
P <sub>tot</sub>	total power dissipation	T <sub>h</sub> = 25 °C; Figure 1	[1] _	23	W
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-	+150	°C

[1] Mounted without heatsink compound.

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## 5. Thermal characteristics

Table 4:	Ihermal	characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-h)</sub>	thermal resistance from junction to heatsink	Mounted without heatsink compound	[1]	-	-	5.5	K/W
		Mounted with heatsink compound	[1]	-	-	3.9	K/W
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient			-	55	-	K/W

[1] External heatsink connected to mounting base.

## 6. Characteristics

### Table 5: Characteristics

 $T_i = 25 \circ C$  unless otherwise specified.

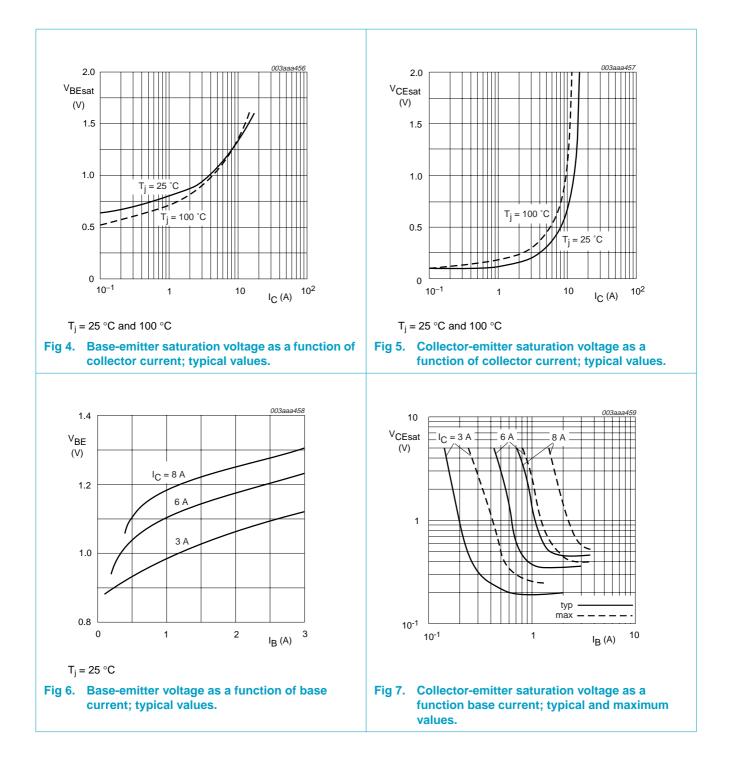
,	,						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static ch	naracteristics						
V <sub>CEOsus</sub>	collector-emitter sustaining voltage	I <sub>C</sub> = 100 mA; I <sub>Boff</sub> = 0 A; L = 25 mH; Figure 9 and 10		400	-	-	V
V <sub>CEsat</sub>	collector-emitter saturation voltage	I <sub>C</sub> = 5 A; I <sub>B</sub> = 1 A; Figure 5		-	-	1.5	V
V <sub>BEsat</sub>	base-emitter saturation voltage	I <sub>C</sub> = 5 A; I <sub>B</sub> = 1 A; Figure 4		-	-	1.5	V
I <sub>CES</sub>	collector-emitter cut-off current	$V_{CE} = V_{CESM}; V_{BE} = 0 V$					
		T <sub>j</sub> = 25 °C	[1]	-	-	1	mA
		T <sub>j</sub> = 125 °C	[1]	-	-	3	mA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = 5 V; Figure 8					
		I <sub>C</sub> = 10 mA		10	18	35	
		I <sub>C</sub> = 1 A		10	20	35	
Dynamic	c characteristics						
t <sub>on</sub>	turn-on time	I <sub>Con</sub> = 5 A; I <sub>Bon</sub> = I <sub>Boff</sub> = 1 A; resistive load; <mark>Figure 11</mark> and <mark>12</mark>		-	-	1	μs
t <sub>s</sub>	carrier storage time	I <sub>Con</sub> = 5 A; I <sub>Bon</sub> = I <sub>Boff</sub> = 1 A; resistive load; Figure 11 and 12	[2]	-	-	4	μs
		$I_{Con} = 5 \text{ A}; I_{Bon} = 1 \text{ A};$ $V_{CL} = 250 \text{ V}; T_{mb} = 100 \text{ °C};$ inductive load; Figure 13 and 14		-	1.9	2.5	μs
t <sub>f</sub>	fall time	I <sub>Con</sub> = 5 A; I <sub>Bon</sub> = I <sub>Boff</sub> = 1 A; resistive load; Figure 11 and 12		-	-	0.8	μs
		$I_{Con} = 5 \text{ A}; I_{Bon} = 1 \text{ A}; V_{CL} = 300 \text{ V};$ $T_{mb} = 100 ^\circ\text{C}; \text{ inductive load};$ Figure 13 and 14		-	200	300	ns

[1] Measured with a half-sinewave voltage.

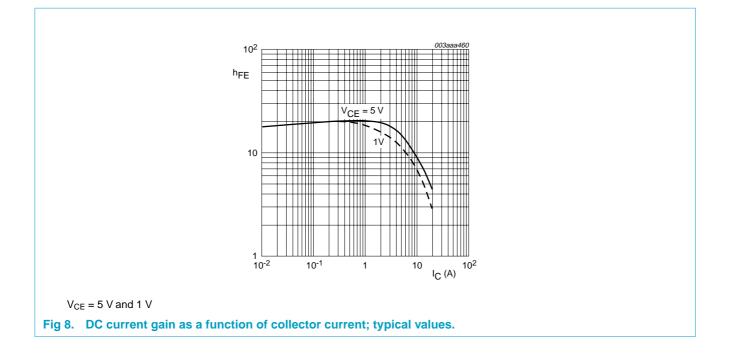
[2] turn-off storage time

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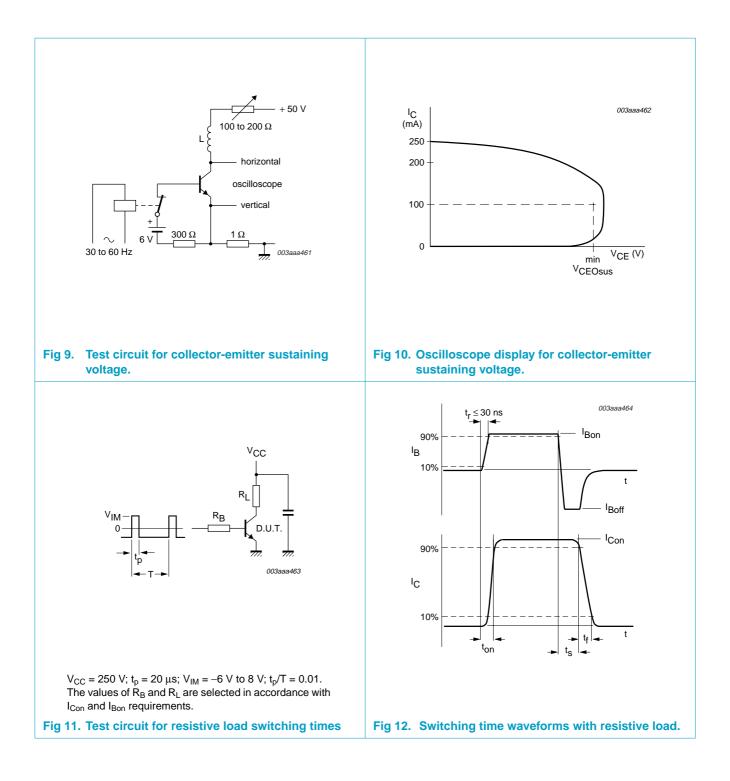
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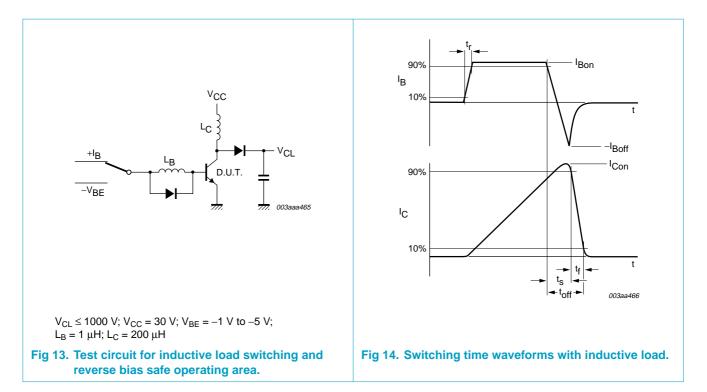


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### Silicon diffused power transistor



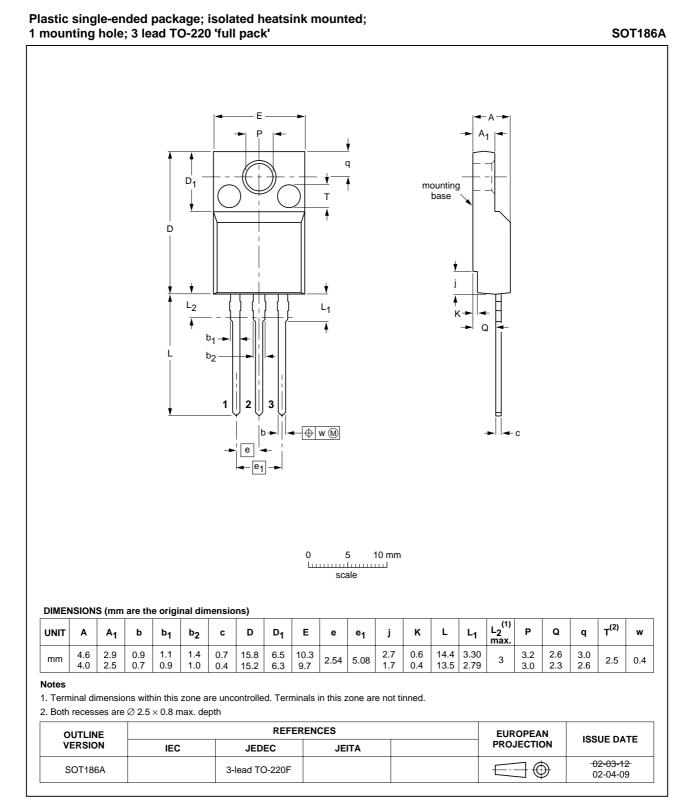
## 7. Isolation characteristics

Table 6:	Isolation characteristics					
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
V <sub>isol(RMS)</sub> M	Peak RMS isolation voltage from all three terminals to external heatsink.	f = 50 to 60 Hz; sinusoidal waveform; RH $\leq$ 65%; clean and dust-free.	-	-	2500	V
C <sub>c-h</sub>	Capacitance from collector to external heatsink.		-	12	-	pF

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### 8. Package outline



#### Fig 15. SOT186A (TO-220F).

9397 750 13442 Product data

# 9. Revision history

Table	7: Revis	ion history	
Rev	Date	CPCN	Description
01	20040616	-	Product data (9397 750 13442)

#### Silicon diffused power transistor

## **10. Data sheet status**

Level	Data sheet status <sup>[1]</sup>	Product status <sup>[2][3]</sup>	Definition
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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